

Product Summary

V_{BR} (Min)	I_{PP} (Max)	C_T (Typ)
13V	4A	0.52pF

Features

- Low Profile Package (0.53mm max) and Ultra-Small PCB Footprint Area (1.08mm × 0.68mm max) Suitable for Compact Portable Electronics
- Provides ESD Protection per IEC 61000-4-2 Standard: Air ±20kV, Contact ±20kV
- One Channel of ESD Protection
- Low Channel Input Capacitance
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **The D12V0X1B2LPQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.**
<https://www.diodes.com/quality/product-definitions/>

Description

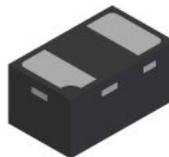
This new generation TVS is designed to protect sensitive electronics from the damage due to ESD. The combination of small size and high ESD surge capability makes it ideal for use in automotive applications such as:

- USB Modules
- HDMI Ports
- LVDS

Mechanical Data

- Case: X1-DFN1006-2
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208@4
- Weight: 0.001 grams (Approximate)

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Bottom View



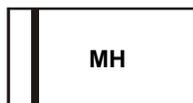
Device Schematic

Ordering Information (Note 4)

Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
D12V0X1B2LPQ-7B	Automotive	MH	7	8	10,000/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information



MH = Product Type Marking Code
Line Denotes Pin 1

Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Current	I_{PP}	4	A	8/20 μs , See Figure 3
ESD Protection—Contact Discharge	$V_{ESD_Contact}$	± 20	kV	IEC 61000-4-2 Standard
ESD Protection—Air Discharge	V_{ESD_Air}	± 20	kV	IEC 61000-4-2 Standard

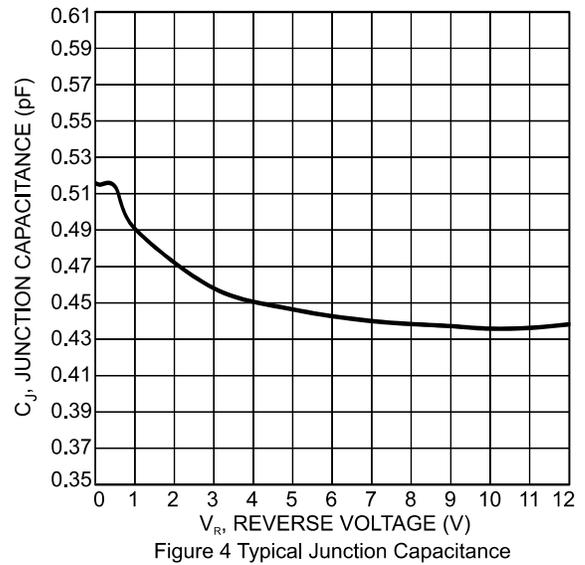
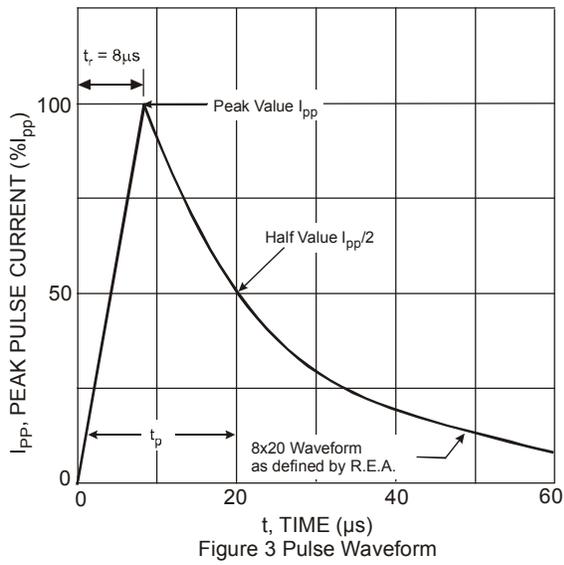
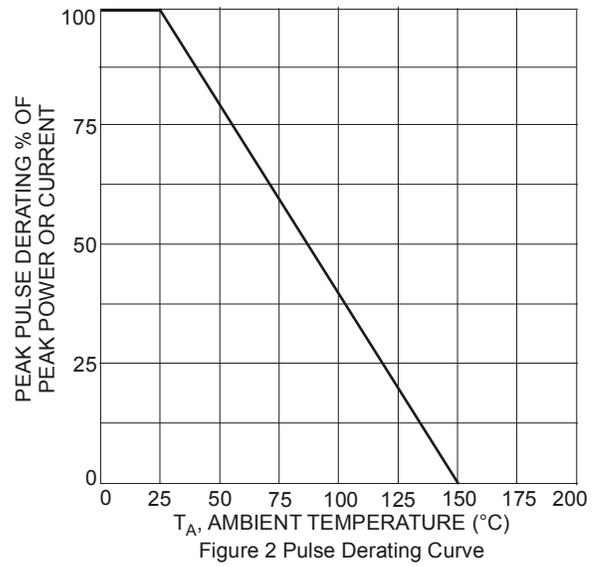
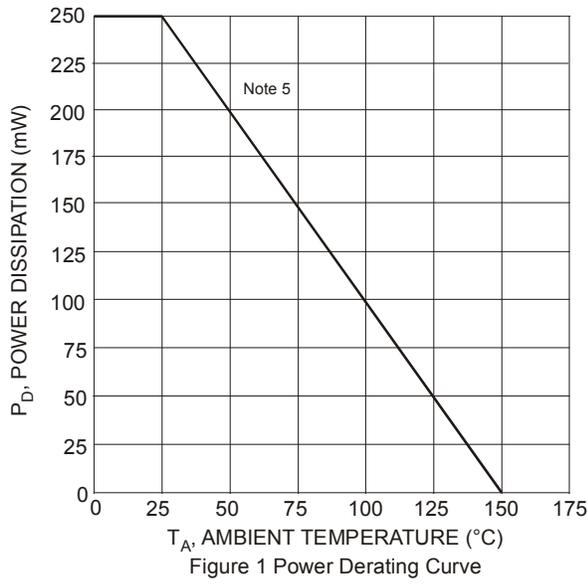
Thermal Characteristics

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 6)	P_D	250	mW
Thermal Resistance, Junction to Ambient (Note 6)	$R_{\theta JA}$	500	$^\circ\text{C/W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	$^\circ\text{C}$

Electrical Characteristics (@ $T_A = +25^\circ\text{C}$ unless otherwise specified)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Conditions
Reverse Working Voltage	V_{RWM}	—	—	12	V	—
Reverse Current (Note 6)	I_R	—	—	1	μA	$V_R = 12\text{V}$
Reverse Breakdown Voltage	V_{BR}	13	—	17.6	V	$I_R = 1\text{mA}$
Reverse Clamping Voltage, Positive Transients	V_{CL}	—	—	18	V	$I_{PP} = 1\text{A}, t_P = 8/20\mu\text{s}$
		—	—	24	V	$I_{PP} = 4\text{A}, t_P = 8/20\mu\text{s}$
Dynamic Resistance	R_{DYN}	—	0.6	—	Ω	$I_R = 1\text{A}, t_P = 8/20\mu\text{s}$
Capacitance	C_T	—	0.52	0.7	pF	$V_R = 0\text{V}, f = 1\text{MHz}$

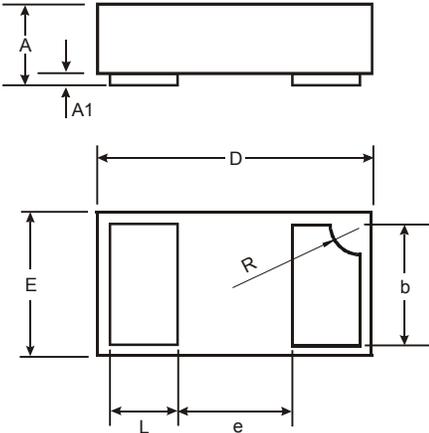
- Notes:
- Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes' suggested pad layout, which can be found on our website at <http://www.diodes.com/package-outlines.html>.
 - Short duration pulse test used to minimize self-heating effect.



Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

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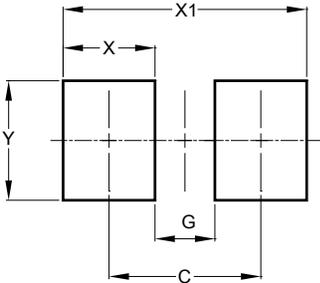


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Dim	Min	Max	Typ
A	0.47	0.53	0.50
A1	0	0.05	0.03
b	0.45	0.55	0.50
D	0.95	1.075	1.00
E	0.55	0.675	0.60
e	-	-	0.40
L	0.20	0.30	0.25
R	0.05	0.15	0.10
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

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Dimensions	Value (in mm)
C	0.70
G	0.30
X	0.40
X1	1.10
Y	0.70

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